



## N- and P-Channel 60-V (D-S) MOSFET

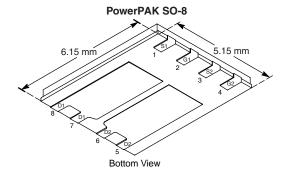
PRODUCT SUMMARY							
	V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
N-Ch	60	0.075 at $V_{GS} = 10 \text{ V}$	4.6	12 nC			
		$0.100 \text{ at V}_{GS} = 4.5 \text{ V}$	4.0	12110			
P-Ch	- 60	$0.064 \text{ at V}_{GS} = -10 \text{ V}$	- 5.0	47			
		0.080 at $V_{GS} = -4.5 \text{ V}$	- 4.5	47			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET
- New Low Thermal Resistance PowerPAK<sup>®</sup> Package with Low 1.07 mm Profile
- 100 % R<sub>q</sub> Tested

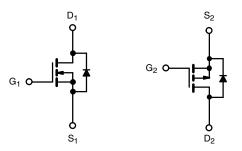






Ordering Information: Si7530DP-T1-E3 (Lead (Pb)-free)

Si7530DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted								
			N-Ch	annel	P-Channel		Unit	
Parameter	Symbol	10 s	Steady	10 s	Steady	Ollit		
Drain-Source Voltage	$V_{DS}$	6	60	-	V			
Gate-Source Voltage	$V_{GS}$		±	20	)			
Continuous Drain Current (T <sub>.1</sub> = 150 °C) <sup>a</sup>	$T_A = 25^{\circ}C$	l <sub>o</sub>	4.6	3.0	- 5.0	- 3.2		
Continuous Diain Current (1) = 130 C)	$T_A = 70^{\circ}C$	l <sub>D</sub>	3.6	2.4	- 4.0	- 2.6	1	
Pulsed Drain Current	I <sub>DM</sub>	1	15	-	Α			
Continuous Source Current (Diode Conductio	I <sub>S</sub>	2.7	1.2	- 2.9 - 1.2				
Single Pulse Avalanche Current	nche Current L = 0.1 mH		15		- 22			
Single Pulse Repetitive Avalanche Energy <sup>b</sup>			1	1	24.2		mJ	
Maximum Power Dissipation <sup>a</sup>	$T_A = 25^{\circ}C$	P <sub>D</sub>	3.3	1.4	3.5	1.5	w	
Maximum Power Dissipation	$T_A = 70^{\circ}C$	, п	2.1	0.9	2.2	0.94	7 "	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>		- 55 t	o 150	°C			
Soldering Recommendations (Peak Temperat			20	60				

THERMAL RESISTANCE RATINGS								
			N-Ch	annel	P-Ch	Unit		
Parameter	Symbol	Typical	Maximum	Typical	Maximum	Oilit		
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	38	27	36		
waximum Junction-to-Ambient*	Steady State	itnJA	60	85	60	85	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	4.0	5.2	3.3	4.3		

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Duty Cycle ≤ 1 %.
- c. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}\text{C}$ , unless otherwise noted									
Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit		
Static									
Gata Throshold Veltage	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	1		3	V		
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	P-Ch	- 1	- 3	V			
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			± 100	nA		
Gate-Body Leakage	GSS		P-Ch			± 100	ш		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 1	μΑ		
Zero date voltage Brain Gunem		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$	N-Ch			5	μΑ		
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$	P-Ch			- 5			
On State Drain Currenta	T	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	15			Α		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 25			^		
		$V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$	N-Ch		0.060	0.075	Ω		
	Ь	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5.0 A	P-Ch		0.051	0.064			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 4.0 \text{ A}$	N-Ch		0.080	0.100			
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.5 A	P-Ch		0.064	0.080			
	_	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 4.6 A	N-Ch		6		_		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5.0 A	P-Ch		16		S		
	W	I <sub>S</sub> = 2.7 A, V <sub>GS</sub> = 0 V	N-Ch		0.85	1.2			
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = - 2.9 A, V <sub>GS</sub> = 0 V	P-Ch		- 0.85	- 1.2	V		
Dynamic <sup>b</sup>									
Total Gate Charge	0		N-Ch		12	20			
Total Gate Charge	Qg	N-Channel $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	P-Ch		26	40			
Gate-Source Charge	$Q_{gs}$	VDS = 50 V, VGS = 10 V, ID = 15 A	N-Ch		2		nC		
	95	P-Channel			4.5				
Gate-Drain Charge	$Q_{gd}$	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5.0 \text{ A}$	N-Ch		3.5				
	9-		P-Ch	0.0	7	0.5			
Gate Resistance	$R_{g}$	f = 1.0 MHz	N-Ch P-Ch	0.6 3.5	1.5 7	2.5 11	Ω		
			N-Ch	3.5	7	15			
Turn-On Delay Time	t <sub>d(on)</sub>	N-Channel	P-Ch		8	15			
		$V_{DD} = 30 \text{ V}, R_L = 30 \Omega$	N-Ch		8	15			
Rise Time	t <sub>r</sub>	$I_D \cong 1 \text{ A, V}_{GEN} = 10 \text{ V, R}_g = 6 \Omega$	P-Ch		9	15			
Town Off Delevi Time		P-Channel	N-Ch		15	25			
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = -30 \text{ V}, R_L = 30 \Omega$	P-Ch		65	100	ns		
Fall Time	t <sub>f</sub>	$I_D \cong -1 \text{ A, V}_{GEN} = -10 \text{ V, R}_g = 6 \Omega$	N-Ch		7	20			
	শ		P-Ch		30	45	_		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.7 A, dI/dt = 100 A/μs	N-Ch		30	60			
Course Brain Novelle Historia	۲rr	I <sub>F</sub> = - 5 A, dI/dt = 100 A/μs	P-Ch		40	80			
Reverse Recovery Energy	nergy 0	I <sub>F</sub> = 2.7 A, dI/dt = 100 A/μs	N-Ch		33	66	рС		
Tioreise Floodyory Energy	~II	$I_F = -5 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}$	P-Ch		57	115			

#### Notes:

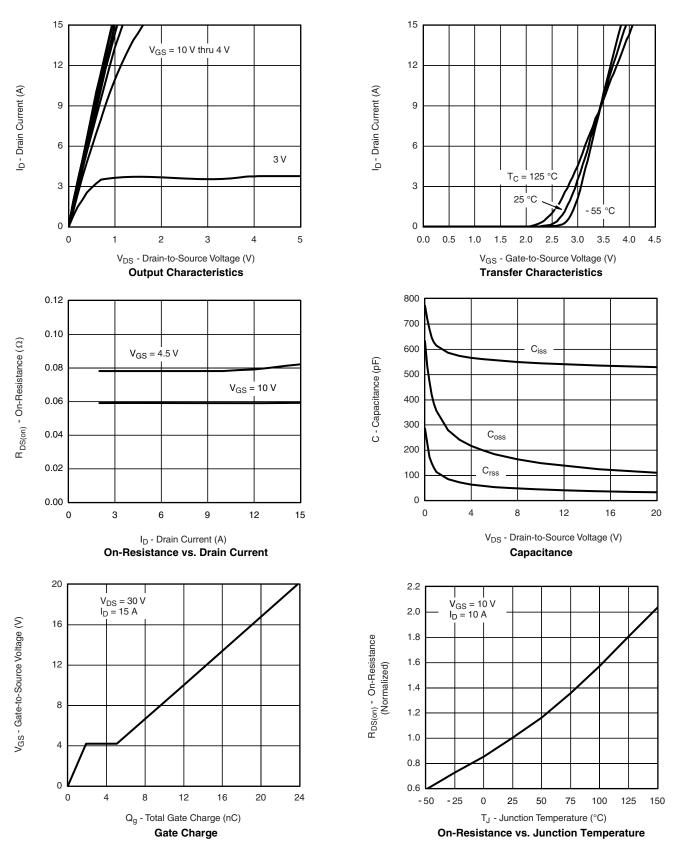
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



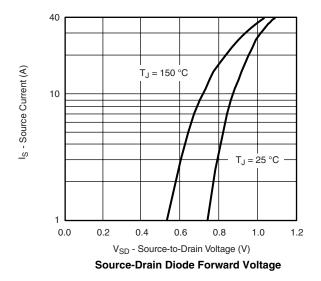


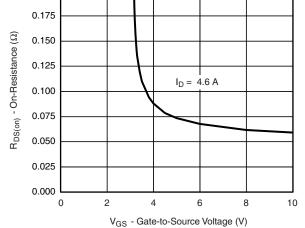
### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



# VISHAY

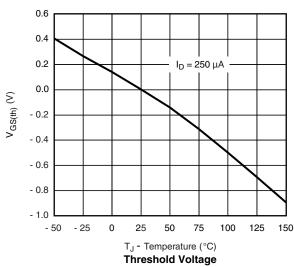
### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

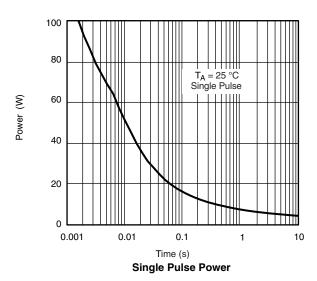


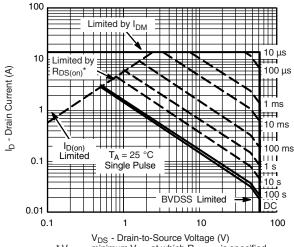


0.200







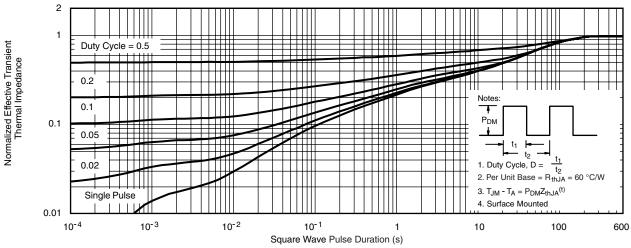


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

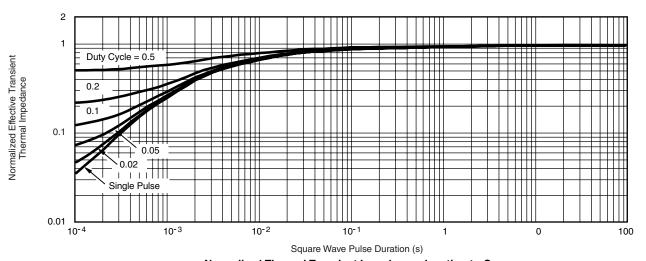
Safe Operating Area, Junction-to-Case



### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



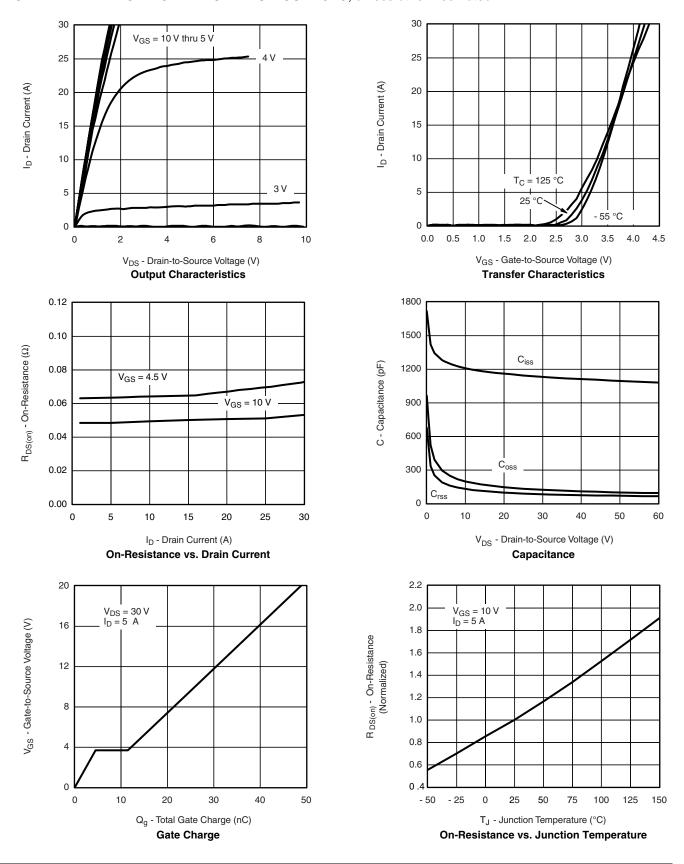
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

# VISHAY.

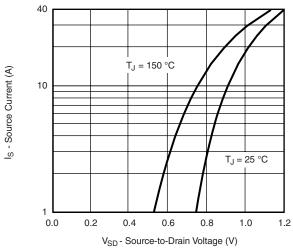
### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



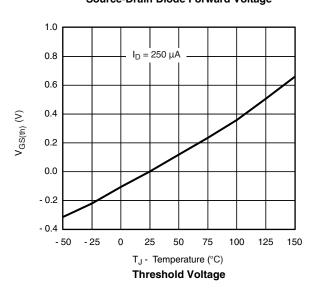


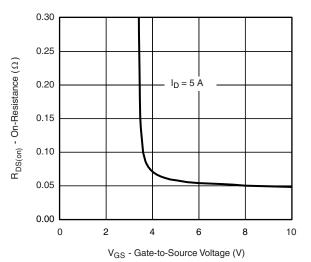


#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

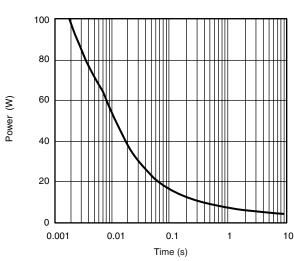




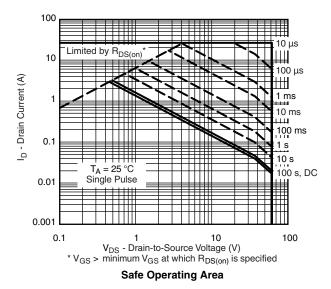




On-Resistance vs. Gate-to-Source Voltage



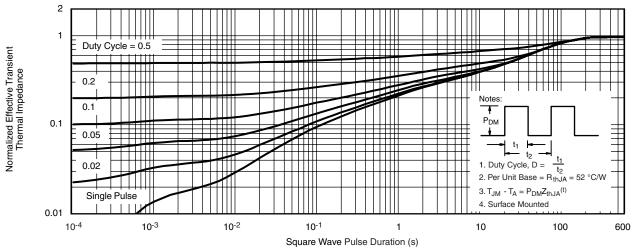
Single Pulse Power, Junction-to-Ambient



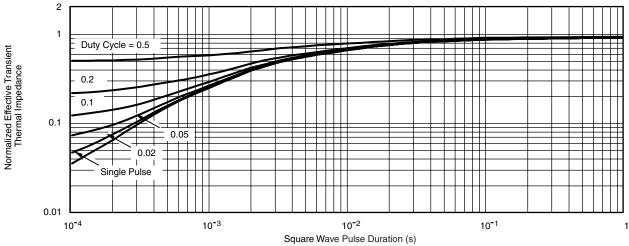
Document Number: 73249 S09-0223-Rev. D, 09-Feb-09



#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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